	PHA & OA			AO4449 30V P-Channel MOSFET				
General Descr	iption			Product Sumn	nary			
The AO4449 uses provide excellent R charge. This device in PWM application	ultra-low low gate	;	V_{DS} $I_{D} (at V_{GS}=-10V)$ $R_{DS(ON)} (at V_{GS}=-10V)$ $R_{DS(ON)} (at V_{GS}=-4.5V)$		-30V -7A < 34mΩ < 54mΩ			
			100% UIS Tested 100% R _g Tested		Green Product			
Absolute Maximum	Ratings Le=	25°C unless othe	erwise n	oted		s		
Parameter			mbol	Maximum		Units		
Drain-Source Voltage			s	-30		V		
Gate-Source Voltage			s	±20		V		
Continuous Drain Current Pulsed Drain Current	T _A =25°C T _A =70°C		<u> </u>	-7 -5.5 -40		A		
Avalanche Current ^C			, I _{AR}	23		A		
Avalanche energy L=	:0.1mH ^C		, i _{ar} _s , E _{ar}	23		mJ		
T _A =25°C				3.1		IIIJ		
Power Dissipation ^B $T_A=70^{\circ}C$		P_	P _D	2		- W		
Junction and Storage Temperature Range			T _{STG}	-55 to 150		°C		
				•				
Thermal Characteris	stics							
Parameter			mbol	Тур	Max	Units		
Maximum Junction-to-Ambient ^A $t \le 10s$			R _{0JA}	31	40	°C/W		
		Steady-State		59	75	°C/W		
Maximum Junction-to	-Lead	Steady-State	$R_{ ext{ heta}JL}$	16	24	°C/W		



Electrical Characteristics (T₁=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V		-30			V
	Zara Cata Valtara Drain Current	V _{DS} =-30V, V _{GS} =0V T _J =55°C				-1	μΑ
IDSS	Zero Gate Voltage Drain Current					-5	
The AO44 Gate-Body leakage current		V_{DS} =0V, V_{GS} = ±20V				±100	nA
V _{GS(th)}	Gate Threshold Voltage V _{DS} =V _{GS} I _D =-250µA			-1.3	-1.85	-2.4	V
I _{D(ON)}	n state drain current V _{GS} =-10V, V _{DS} =-5V			-40			Α
R _{DS(ON)}		V _{GS} =-10V, I _D =-7A			21	34	mΩ
	Static Drain-Source On-Resistance		T _J =125°C		31.5	38	
		V _{GS} =-4.5V, I _D =-5A		33	54	mΩ	
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-7A			18		S
V _{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V			-0.8	-1	V
ls	Maximum Body-Diode Continuous Current					-3.5	Α
DYNAMIC	C PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz			760		pF
C _{oss}	Output Capacitance				140		pF
C _{rss}	Reverse Transfer Capacitance				95		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		1.5	3.2	5	Ω
SWITCHI	NG PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =-10V, V _{DS} =-15V, I _D =-7A			13.6	16	nC
Q _g (4.5V)	Total Gate Charge				6.7	8	nC
Q _{gs}	Gate Source Charge				2.5		nC
Q _{gd}	Gate Drain Charge				3.2		nC
t _{D(on)}	Turn-On DelayTime		V _{GS} =-10V, V _{DS} =-15V, R _L =2.15Ω,		8		ns
t _r	Turn-On Rise Time	V _{GS} =-10V, V _{DS} =-15V			6		ns
t _{D(off)}	Turn-Off DelayTime	R _{GEN} =3Ω			17		ns
t _f	Turn-Off Fall Time				5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-7A, dl/dt=100A/μ		15		ns	
Q _{rr}	Body Diode Reverse Recovery Charge	e I _F =-7A, dl/dt=100A/μ	I _F =-7A, dl/dt=100A/μs				nC

A. The value of R_{0.14} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using \leq 10s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initialT₁=25° C.

D. The R_{0JA} is the sum of the thermal impedence from junction to lead R_{0JL} and lead to ambient. E. The static characteristics in Figures 1 to 6 are obtained using <300 μ s pulses, duty cycle 0.5% max.

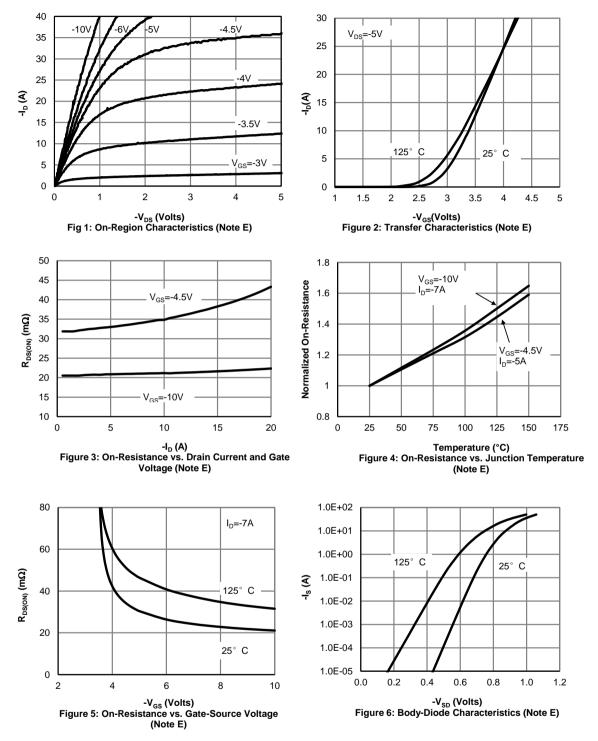
F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

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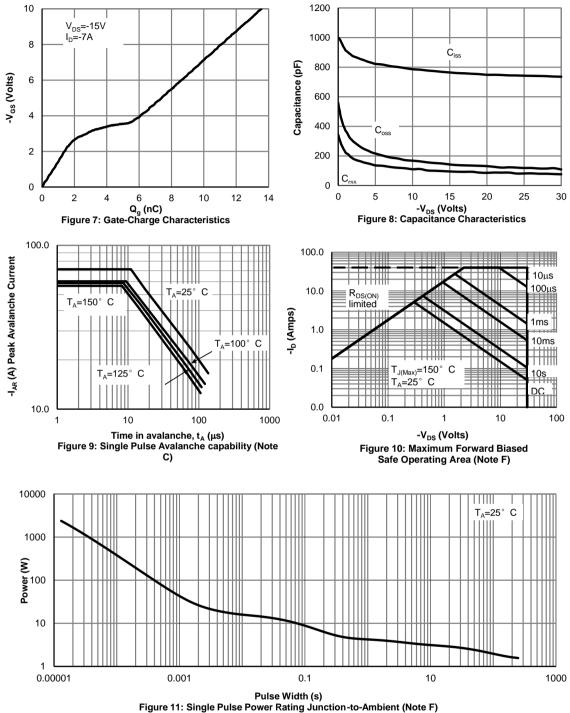


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





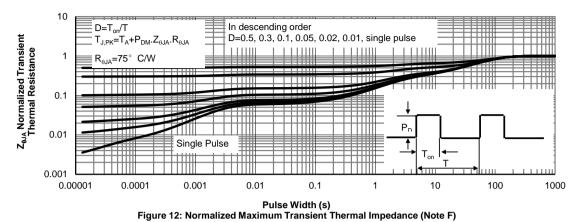
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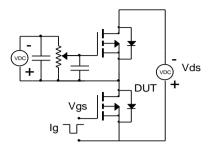


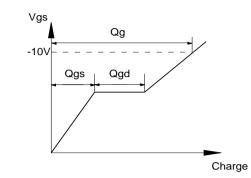
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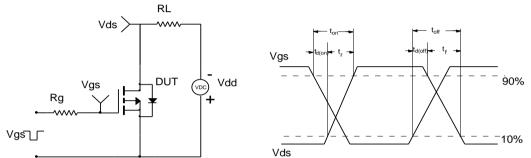


Gate Charge Test Circuit & Waveform

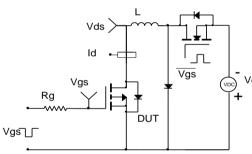


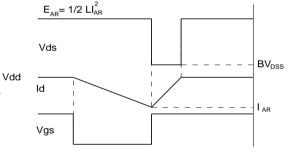


Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

